PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	life.augmented	STMicroelectronics International N.V
1.2 PCN No.		MDG/24/14094
1.3 Title of PCN		ST CALAMBA(Philippines) assembly plant transfer from UTAC (Thailand) for BLUENRG-1x/2x listed products in VQFN5x5 and VQFN6x6 packages
1.4 Product Category		BLUENRG-132 BLUENRG-232x BLUENRG-248 BLUENRG-M2Sx
1.5 Issue date		2024-05-23

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Ricardo Antonio DE SA EARP	
2.1.2 Marketing Manager	Veronique BARLATIER	
2.1.3 Quality Manager	Pascal NARCHE	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	ST CALAMBA (Philippines)	

4. Description of change			
	Old	New	
4.1 Description	UTAC UTL1 (Thailand) assembly Wettable flank package - gold bonding wire - VFQFN32 5X5 F174 F157 - VFQFN48 6X6 F174	ST CALAMBA (Philippines) assembly non- Wettable flank standard QFN package - copper alloy bonding wire - VFQFN32 5X5 F174 F157 - VFQFN48 6X6 F174	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Standard QFN Package compatible with previous one		

5. Reason / motivation for change		
5.1 Motivation	package rationalization	
5.2 Customer Benefit	SERVICE IMPROVEMENT	

6. Marking of parts / traceability of change	
6.1 Description	traceability ensured by ST internal tools

7. Timing / schedule		
7.1 Date of qualification results	2024-06-17	
7.2 Intended start of delivery	2024-06-26	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description	14094 MDG-GPM-RER2309 PCN14094 ST CALAMBA BLUENRG in .pdf	VQFN UTA	C - Reliability plan
8.2 Qualification report and qualification results		Issue Date	2024-05-23

9. Attachments (additional documentations)

14094 Public product.pdf 14094 MDG-GPM-RER2309 PCN14094 ST CALAMBA BLUENRG in VQFN UTAC - Reliability plan .pdf 14094 PCN14094_Additional information.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	BLUENRG-132	
	BLUENRG-232	
	BLUENRG-232N	
	BLUENRG-248	
	BLUENRG-M2SA	
	BLUENRG-M2SP	



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: ST CALAMBA(Philippines) assembly plant transfer from UTAC (Thailand) for BLUENRG-1x/2x listed products in

VQFN5x5 and VQFN6x6 packages **PCN Reference**: MDG/24/14094

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

BLUENRG-M2SP	BLUENRG-M2SA	BLUENRG-232
BLUENRG-232N	BLUENRG-248	BLUENRG-132



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